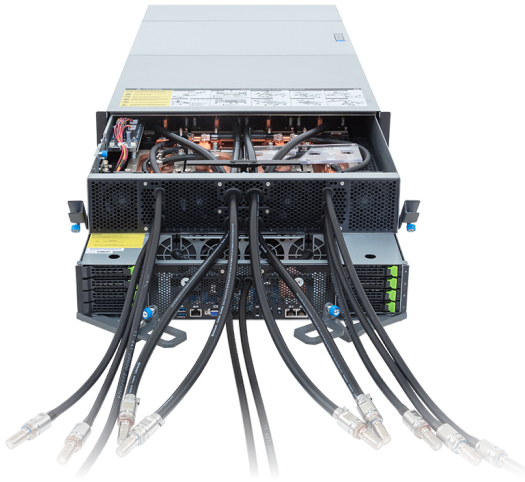


G4L4-SD1-LAX5

HPC/AI Server - Intel® Xeon® 6 - 4U DP NVIDIA HGX™ B200 DLC



Key Features

- Liquid-cooled NVIDIA HGX™ B200
- CPU+GPU direct liquid cooling solution with leak detection
- 1.8TB/s GPU-to-GPU bandwidth with NVIDIA NVLink™ and NVSwitch™
- Dual Intel® Xeon® 6700/6500-Series Processors
- 8-Channel DDR5 RDIMM / MRDIMM, 32 x DIMMs
- Compatible with NVIDIA® BlueField®-3 DPUs and NVIDIA ConnectX®-7 NICs
- 2 x 10Gb/s LAN ports via Intel® X710-AT2
- 2 x M.2 slots with PCIe Gen5 x4 and x2 interface
- 8 x 2.5" Gen5 NVMe hot-swap bays
- 4 x FHHL dual-slot PCIe Gen5 x16 slots
- 8 x FHHL single-slot PCIe Gen5 x16 slots
- 4+4 3000W 80 PLUS Titanium redundant power supplies

Specification

Dimensions	4U (W447 x H175.5 x D901 mm)	Modular GPU	Liquid-cooled NVIDIA HGX™ B200 with 8 x SXM GPUs
Motherboard	MSB4-PE0	PCIe Expansion Slots	4 x FHHL dual-slot PCIe Gen5 x16 8 x FHHL single-slot PCIe Gen5 x16 *The ambient temperature is limited to 30°C when NVIDIA® BlueField®-3 DPUs/SuperNIC™ are installed.
CPU	Intel® Xeon® 6 Processors - Intel® Xeon® 6700-Series Processors - Intel® Xeon® 6500-Series Processors Dual processor, TDP up to 350W	I/O Ports	Front: 2 x USB 3.2 Gen1, 1 x VGA, 2 x RJ45, 1 x MLAN (default) Rear: 1 x MLAN
OS Compatibility	OS Support List	Backplane Board	PCIe Gen5 x4
Socket	2 x LGA 4710 (Socket E2)	TPM	1 x TPM header (SPI), Optional TPM2.0 kit: CTM012
Chipset	System on Chip	Power Supply	4+4 3000W 80 PLUS Titanium redundant power supplies AC Input: 115-240V *The system power supply requires C19 power cord.
Memory	8-Channel DDR5 RDIMM/MRDIMM, 32 x DIMMs [RDIMM] Up to 6400 MT/s (1DPC), 5200 MT/s (2DPC) [MRDIMM] Up to 8000 MT/s [1] [1] MRDIMMs are supported only on select Intel® Xeon® 6 processors with P-cores and only in a 1DPC configuration.	System Fans	Motherboard: 2 x 60x60x56mm 2 x 60x60x76mm PCIe slots: 4 x 80x80x56mm GPU tray: 4 x 60x60x38mm
LAN	Front: 2 x 10Gb/s LAN (1 x Intel® X710-AT2), Support NCSI 1 x 10/100/1000 Mbps Management LAN Rear: 1 x 10/100/1000 Mbps Management LAN	Operating Properties	Operating: 10°C to 35°C, 8% to 80% (non-condensing) Non-operating: -40°C to 60°C, 20% to 95% (non-condensing) *To ensure system stability and prevent condensation, when the relative humidity exceeds 50%, the coolant inlet temperature must be higher than the dry-bulb temperature and it should not exceed 45°C.
Video	Integrated in ASPEED® AST2600 - 1 x VGA port	Packaging Content	1 x G4L4-SD1-LAX5 4 x Carriers 1 x L-shape Rail kit
Storage	Front hot-swap: 8 x 2.5" Gen5 NVMe Internal M.2: 1 x M.2 (2280/22110), PCIe Gen5 x4 1 x M.2 (2280/22110), PCIe Gen5 x2	Ordering Part Numbers	6NG4L4SD1DR000LAX5*



Learn more at: <https://www.gigabyte.com/Enterprise>

* All specifications are subject to change without notice. Please visit our website for the latest information.

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